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Jae-June Kim

Execution Date(s) October 7, 2005

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Name: Easetech Korea Co., Ltd.

Internal Address: _____

Street Address: Room 504, Insagwan, Kangnam

University San 6-2, Kugalri, Kiheungub,

City: Yongin-si, Kyounggi-do 449-702

State: _____

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4. Application or patent number(s):

A. Patent Application No.(s)

11/245,962

☒ This document is being filed together with a new application.

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Michael J. Hughes

Internal Address: _____

Street Address: Intellectual Property Law Offices

1901 S. Bascom Ave., Suite 660

City: Campbell

State: CA Zip: 95008

Phone Number: (408) 558-9950

Fax Number: (408) 558-9960

Email Address: efiler@iplo.com

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

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9. Signature:

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Signature

March 28, 2006

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Michael J. Hughes

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CH \$40.00 083240 11245962

File No.: 60790,300101

ASSIGNMENT

I, as a below-named inventor, for good and valuable consideration, receipt of which is hereby acknowledged, have assigned and do hereby assign to:

Easotech Korea Co., Ltd.
Room 504, Insagwan, Kangnam University San 6-2,
Kugulri, Kihcungub, Yongin-si, Kyoungki-do
449-702, Republic of Korea

a Korean corporation (hereinafter referred to as Assignee), its successors, assigns and legal representatives, the entire right, title and interest in and to all subject matter invented by Jae-June KIM and disclosed and/or claimed in an application for Letters Patent of the United States of America Serial No. (pending) filed (concurrently herewith), entitled:

METHOD FOR MANUFACTURING WAFER LEVEL CHIP SCALE PACKAGE USING REDISTRIBUTION SUBSTRATE

and signed by me



On the date set forth below;
on the DATE_OF_SIGNING_DECLARATION

and in and to any and all divisions, reissues, continuations and extensions thereof; and in and to all corresponding applications for Letters Patent and all Convention and Treaty Rights of any kind, in all countries throughout the world, for all such subject matter.

I hereby authorize and request that the Patent Office Officials in the United States, and in countries foreign to the United States, issue any and all of said Letters Patent or similar documents, when granted, to said Assignee, as the Assignee of our entire right, title and interest in and to the same, for the sole use and enjoyment of said Assignee, its successors and assigns.

Further, I agree that I will communicate to said Assignee, or its representatives, any facts known to me respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisions, continuations, substitutions, and renewal reexamination and reissue applications, execute all necessary Assignment papers to cause any and all of said Letters Patent to be issued to said Assignee, make all rightful oaths and generally do everything necessary or desirable to aid said Assignee, its successors and assigns, to obtain and enforce proper protection for said invention in the United States.

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File No.: 60790.300101

In Testimony Whereof, I hereunto set my hand.

SIGNATURES

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